

**Features**

- The plastic package carries Underwriters Laboratory Flammability Classification 94V-0
- Construction utilizes void-free molded plastic technique
- Low reverse leakage
- High forward surge current capability
- High temperature soldering guaranteed 260°C/10 seconds at terminals

**Mechanical Data**

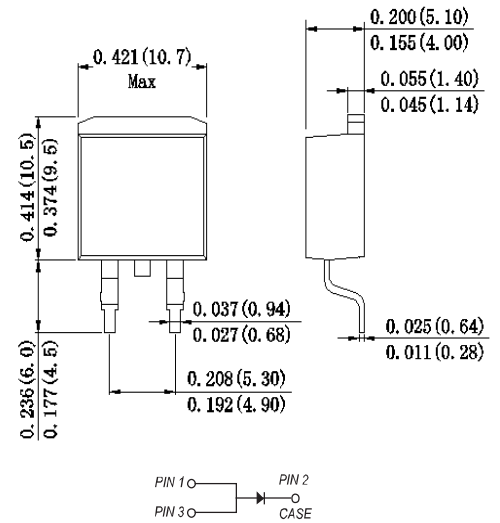
**Case :** Molded plastic body

**Terminals :** Solder plated, solderable per MIL-STD-750,Method 2026

**Polarity :** Polarity symbol marking on body

**Mounting Position :** Any

TO-263



Dimensions in inches and (millimeters)

**Maximum Ratings** (Ta=25 unless otherwise specified)

| PARAMETER  | SYMBOLS           | MBR3050Y    | UNITS |
|--|-------------------|-------------|-------|
| Maximum repetitive peak reverse voltage  | V <sub>RRM</sub>  | 50          | V     |
| Maximum RMS voltage  | V <sub>RMS</sub>  | 35          | V     |
| Maximum DC blocking voltage  | V <sub>DC</sub>   | 50          | V     |
| Maximum average forward rectified current at T <sub>c</sub> =110°C                 | I <sub>(AV)</sub> | 30.0        | A     |
| Peak forward surge current, 8.3ms single half sine-wave superimposed on rated load | I <sub>FSM</sub>  | 250.0       | A     |
| Typical thermal resistance   | R <sub>qJC</sub>  | 4.0         | °C/W  |
| Operating junction temperature range   | T <sub>J</sub>    | -55 to +150 | °C    |
| Storage temperature range  | T <sub>STG</sub>  | -55 to +150 | °C    |

**Electrical Characteristics** (Ta=25 unless otherwise specified)

| PARAMETER  | SYMBOLS        | TYPE                  | MAX  | UNITS |
|--|----------------|-----------------------|------|-------|
| Maximum instantaneous forward voltage per diode at 30.0A | V <sub>F</sub> | 0.56                  | 0.63 | V     |
| Maximum DC reverse current at rated DC blocking voltage  | I <sub>R</sub> | T <sub>A</sub> =25°C  | 50   | u A   |
|  |                | T <sub>A</sub> =100°C | 2    | mA    |

Ratings And Characteristic Curves

FIG. 1- DERATING CURVE OUTPUT RECTIFIED CURRENT

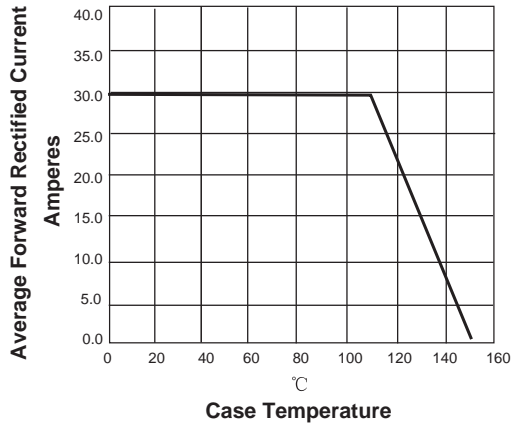


FIG. 2-MAXIMUM NON-REPETITIVE PEAK FORWARD SURGE CURRENT PER LEG

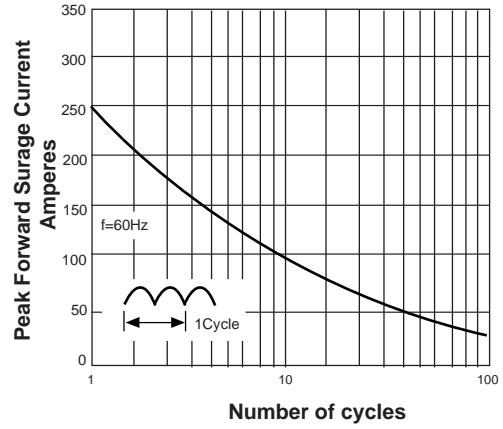


FIG. 3-TYPICAL FORWARD VOLTAGE CHARACTERISTICS

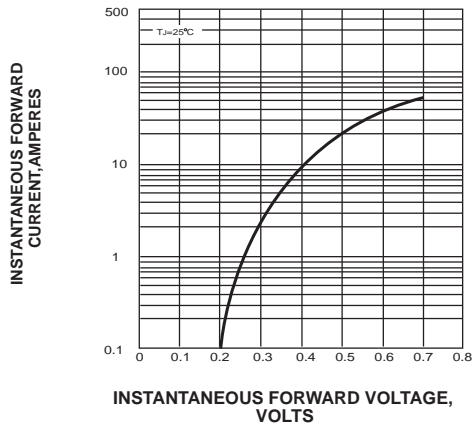
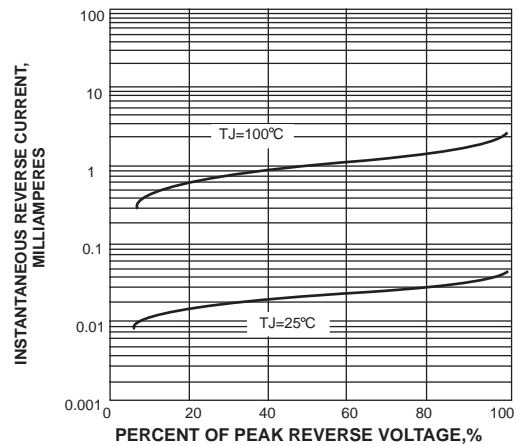
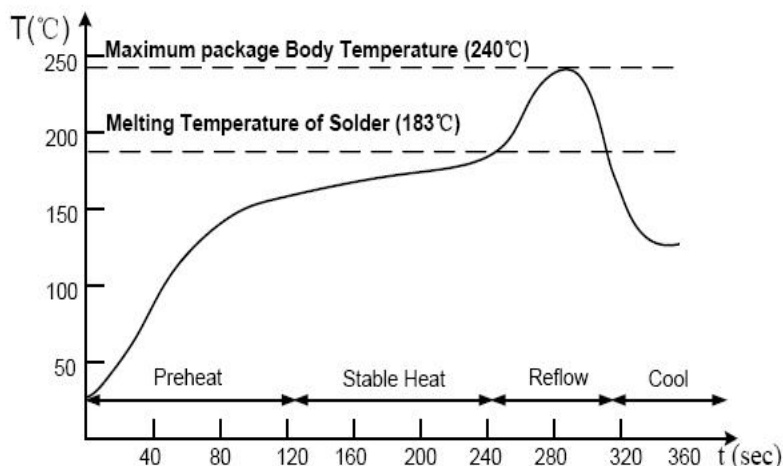


FIG. 4-TYPICAL REVERSE LEAKAGE CHARACTERISTICS



## Suggested Soldering Temperature Profile



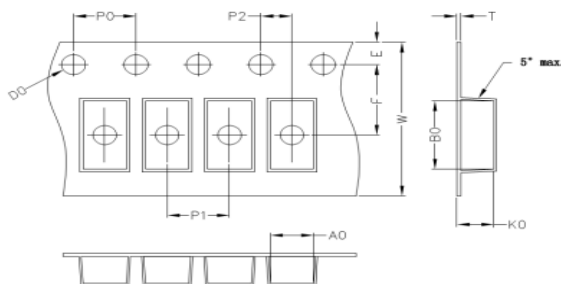
### Note

- Recommended reflow methods: IR, vapor phase oven, hot air oven, wave solder.
- The device can be exposed to a maximum temperature of 265°C for 10 seconds.
- Devices can be cleaned using standard industry methods and solvents.
- If reflow temperatures exceed the recommended profile, devices may not meet the performance requirements.

## Package Information

### ➤ Reel Package

#### Carrier Dimension(mm)



| A0   | B0    | K0   | D0   | E    | F         |
|------|-------|------|------|------|-----------|
| 10.5 | 15.55 | 4.90 | 1.50 | 1.75 | 11.5      |
| P0   | P1    | P2   | T    | W    | Tolerance |
| 4.0  | 16.0  | 2.0  | 0.4  | 24   | 0.1       |

### Package Specifications

| Package | Reel Size | Reel DIA. (mm) | Q'TY/Reel (Kpcs) | Box Size (mm) | QTY/Box (Kpcs) | Carton Size (mm) | Q'TY/Carton (Kpcs) |
|---------|-----------|----------------|------------------|---------------|----------------|------------------|--------------------|
| TO-263  | 13'       | 330            | 0.8              | 340           | 0.8            | 360*360*360      | 6.4                |

### ➤ Tube Package

| Package  | Tube (mm)    | Q'TY/Tube (Kpcs) | Box Size (mm) | QTY/Box (Kpcs) | Carton Size (mm) | Q'TY/Carton (Kpcs) |
|----------|--------------|------------------|---------------|----------------|------------------|--------------------|
| TO - 263 | 525*31.9*6.4 | 0.05             | 545*150*45    | 1.0            | 575*245*170      | 5.0                |